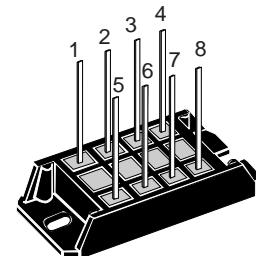
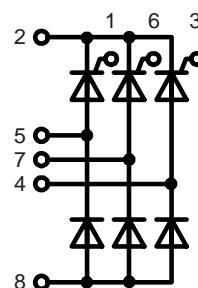


Three Phase Half Controlled Rectifier Bridge

$I_{dAVM} = 43 \text{ A}$
 $V_{RRM} = 1200-1600 \text{ V}$

V_{RSM} V_{DSM} V	V_{RRM} V_{DRM} V	Type
1300	1200	VVZ 40-12io1
1500	1400	VVZ 40-14io1
1700	1600	VVZ 40-16io1



Symbol	Test Conditions	Maximum Ratings		
I_{dAV}	$T_K = 100^\circ\text{C}$; module	34	A	
I_{dAVM}	module	43	A	
I_{FRMS}, I_{TRMS}	per leg	25	A	
I_{FSM}, I_{TSM}	$T_{VJ} = 45^\circ\text{C}$; $V_R = 0$	320 340	A A	
	$T_{VJ} = T_{VJM}$ $V_R = 0$	290 310	A A	
I^2t	$T_{VJ} = 45^\circ\text{C}$ $V_R = 0$	510 485	A^2s A^2s	
	$T_{VJ} = T_{VJM}$ $V_R = 0$	420 400	A^2s A^2s	
$(di/dt)_{cr}$	$T_{VJ} = T_{VJM}$ $f = 400 \text{ Hz}, t_p = 200 \mu\text{s}$ $V_D = 2/3 V_{DRM}$ $I_G = 0.3 \text{ A}$, $di_G/dt = 0.3 \text{ A}/\mu\text{s}$	repetitive, $I_T = 50 \text{ A}$ non repetitive, $I_T = 1/3 \cdot I_{dAV}$	150 500	$\text{A}/\mu\text{s}$
$(dv/dt)_{cr}$	$T_{VJ} = T_{VJM}; V_{DR} = 2/3 V_{DRM}$ $R_{GK} = \infty$; method 1 (linear voltage rise)	1000	$\text{V}/\mu\text{s}$	
V_{RGM}		10	V	
P_{GM}	$T_{VJ} = T_{VJM}$ $I_T = I_{TAVM}$	$t_p = 30 \mu\text{s}$ $t_p = 500 \mu\text{s}$ $t_p = 10 \text{ ms}$	≤ 10 ≤ 5 ≤ 1	W
P_{GAVM}			0.5	W
T_{VJ}			-40...+125	$^\circ\text{C}$
T_{VJM}			125	$^\circ\text{C}$
T_{stg}			-40...+125	$^\circ\text{C}$
V_{ISOL}	50/60 Hz, RMS $I_{ISOL} \leq 1 \text{ mA}$	$t = 1 \text{ min}$ $t = 1 \text{ s}$	3000 3600	V_\sim
M_d	Mounting torque	(M5) (10-32 UNF)	2-2.5 18-22	Nm lb.in.
Weight	typ.		28	g

Data according to IEC 60747 and refer to a single thyristor/diode unless otherwise stated.
 IXYS reserves the right to change limits, test conditions and dimensions.

Features

- Package with DCB ceramic base plate
- Isolation voltage 3600 V~
- Planar passivated chips
- Soldering terminals
- UL registered E 72873

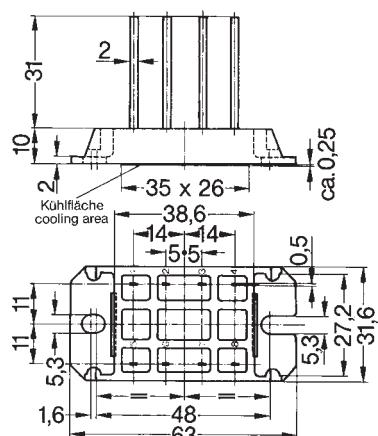
Applications

- Input rectifier for switch mode power supplies (SMPS)
- Softstart capacitor charging
- Electric drives and auxiliaries

Advantages

- Easy to mount with two screws
- Space and weight savings
- Improved temperature and power cycling

Dimensions in mm (1 mm = 0.0394")



Symbol	Test Conditions	Characteristic Values		
I_R, I_D	$V_R = V_{RRM}; V_D = V_{DRM}$ $T_{VJ} = T_{VJM}$ $T_{VJ} = 25^\circ C$	\leq	5	mA
V_F, V_T	$I_F, I_T = 30 A, T_{VJ} = 25^\circ C$	\leq	1.33	V
V_{TO}	For power-loss calculations only		0.85	V
r_T	$(T_{VJ} = 125^\circ C)$		15	$m\Omega$
V_{GT}	$V_D = 6 V;$ $T_{VJ} = 25^\circ C$ $T_{VJ} = -40^\circ C$	\leq	1.0	V
I_{GT}	$V_D = 6 V;$ $T_{VJ} = 25^\circ C$ $T_{VJ} = -40^\circ C$ $T_{VJ} = 125^\circ C$	\leq	65	mA
\leq	\leq	80	mA	
\leq	\leq	50	mA	
V_{GD}	$T_{VJ} = T_{VJM};$ $V_D = 2/3 V_{DRM}$	\leq	0.2	V
I_{GD}	$T_{VJ} = T_{VJM};$ $V_D = 2/3 V_{DRM}$	\leq	5	mA
I_L	$I_G = 0.3 A; t_G = 30 \mu s$ $di_G/dt = 0.3 A/\mu s$	$T_{VJ} = 25^\circ C$ $T_{VJ} = -40^\circ C$ $T_{VJ} = 125^\circ C$	\leq	150 mA
			\leq	200 mA
			\leq	100 mA
I_H	$T_{VJ} = 25^\circ C; V_D = 6 V; R_{GK} = \infty$	\leq	100	mA
t_{gd}	$T_{VJ} = 25^\circ C; V_D = 1/2 V_{DRM}$ $I_G = 0.3 A; di_G/dt = 0.3 A/\mu s$	\leq	2	μs
t_q	$T_{VJ} = 125^\circ C; I_T = 15 A, t_p = 300 \mu s, -di/dt = 10 A/\mu s$	typ.	150	μs
Q_r	$V_R = 100 V, dv/dt = 20 V/\mu s, V_D = 2/3 V_{DRM}$		75	μC
R_{thJC}	per thyristor (diode); DC current		1.0	K/W
	per module		0.17	K/W
R_{thJH}	per thyristor (diode); DC current		1.6	K/W
	per module		0.27	K/W
d_s	Creeping distance on surface		7	mm
d_A	Creepage distance in air		7	mm
a	Max. allowable acceleration		50	m/s^2